# imall

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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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## Contact us

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#### Features

- 5050 top view SMD LED
- High Brightness
- AlInGaP / InGaN Technology
- Small package
- High reliability
- Clear Lens

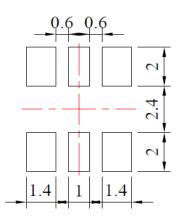
## Applications

- Consumer Electronics
- Light pipe application
- Automobile After Market
- Industrial Equipment

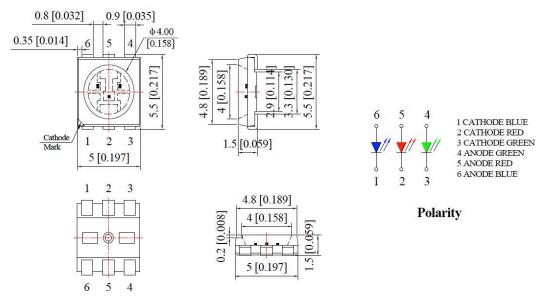
#### Description

The IN-P55TATRGB is a popular low profile RGB 5050 package with versatile design capabilities. It is a PLCC type LED which can be used in various applications.

## **Recommended Solder Pattern**



#### Figure 1. IN-P55TATRGB Solder Pattern



#### Package Dimensions in mm



## Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> * (mA)	V <sub>R</sub> (V)	T₀₽ (ºC)	Ts⊤ (ºC)
IN-P55TATRGB	Red	60	25	100	5	-40°C~+80°C	-40°C~+85°C
IN-P55TATRGB	Green	95	25	100	5	-40°C~+80°C	-40°C~+85°C
IN-P55TATRGB	Blue	95	25	100	5	-40°C~+80°C	-40°C~+85°C

#### Notes

1. Condition for IFP is pulse of 1/10 duty and 0.1msec width

#### Electrical Characteristics T<sub>A</sub> = 25°C (Note 1)

Product	Emission Color	Emission		(V)		λ(nm)		Viewing Angle	l*∨(mcd)
		l⊧(mA)	min	max	λD	λP	∆∆	<b>2</b> \theta 1/2	typ.
IN-P55TATRGB	Red	20	1.6	2.4	624	632	20	120	900
IN-P55TATRGB	Green	20	2.8	3.4	.4 520 525		35	120	1800
IN-P55TATRGB	Blue	20	2.8	3.4	468	470	25	120	600

#### Notes

1. Performance guaranteed only under conditions listed in above tables.

#### **ESD** Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).



## Luminous Intensity (Iv) Bin:

Color	Bin Code	Spec. Range				
	B1	600-700 mcd				
	B2	700-800 mcd				
Red	B3	800-900 mcd				
Reu	B4	900-1000 mcd				
	B5	1000-1100 mcd				
	B6	1100-1200 mcd				
	E1	1500-1600 mcd				
	E2	1600-1700 mcd				
Green	E3	1700-1800 mcd				
Green	E4	1800-1900 mcd				
	E5	1900-2000 mcd				
	E6	2000-2100 mcd				
	H1	300-400 mcd				
	H2	400-500 mcd				
Blue	H3	500-600 mcd				
Diue	H4	600-700 mcd				
	H5	700-800 mcd				
	H6	800-900 mcd				

@20mA / Ta=25<sup>°</sup> C, Tolerance:  $\pm$  10%

#### Dominant Wavelength (λD) Bin:

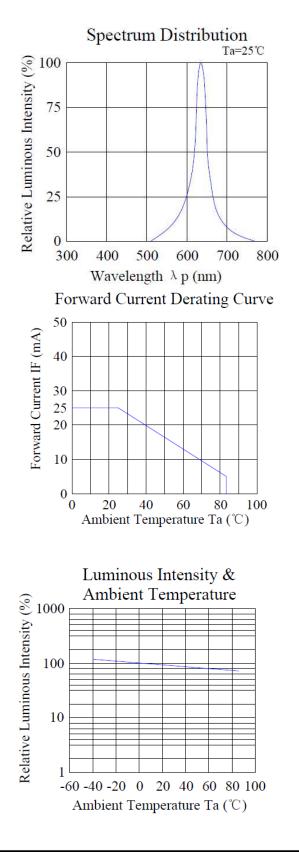
Bin Code	Spec. Range
A1	620-625 nm
A2	625-630 nm
A3	630-635 nm
D1	520-525 nm
D2	525-530 nm
D3	530-535 nm
G1	460-465 nm
G2	465-470 nm
G3	470-475 nm
	A1 A2 A3 D1 D2 D3 G1 G2

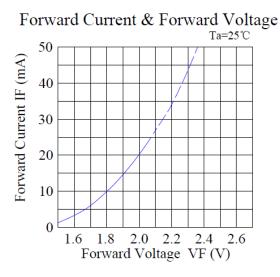
#### Forward Voltage (Vf) Bin:

<u> </u>							
Color	Bin Code	Spec. Range					
	C0	1.80-2.00 V					
Red	C1	2.00-2.20 V					
	C2	2.20-2.40 V					
	F1	2.80-3.00 V					
Green	F2	3.00-3.20 V					
	C0 C1 C2 F1	3.20-3.40 V					
	V1	2.80-3.00 V					
Blue	V2	3.00-3.20 V					
	C0   C1   C2   F1   Green F2   F3   V1   Blue V2	3.20-3.40 V					

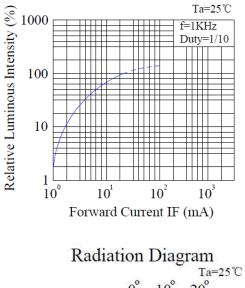


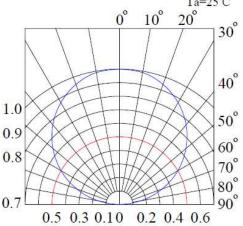
#### **Typical Characteristic Curves-Red**





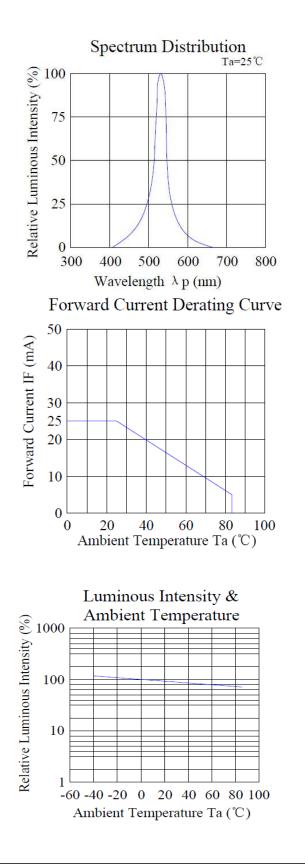
Luminous Intensity & Forward Current

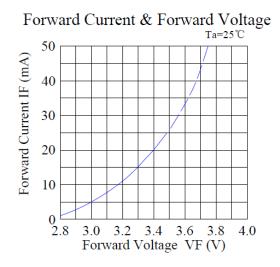




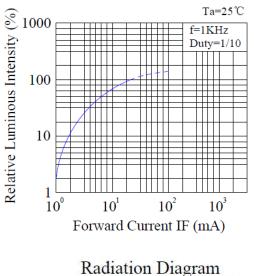


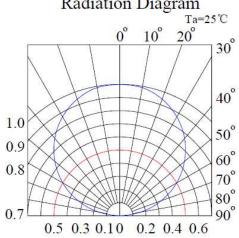
#### **Typical Characteristic Curves-Green**





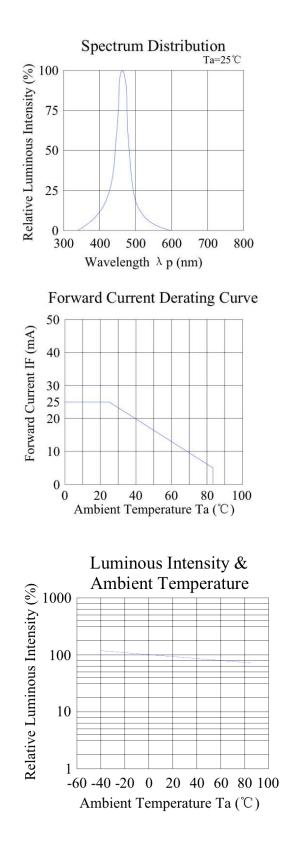
Luminous Intensity & Forward Current

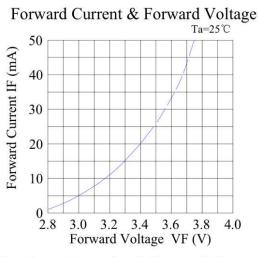


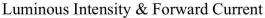


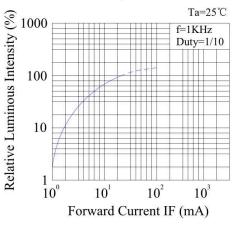


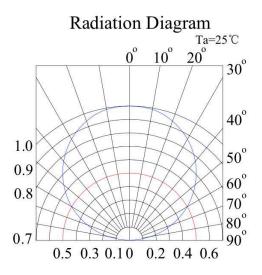
#### **Typical Characteristic Curves-Blue**













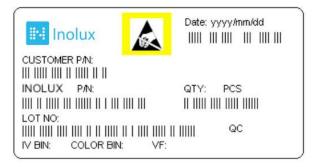
## **Ordering Information**

Product	Emission Color	Technology	Test Current I <sub>F</sub> (mA)	Luminous Intensity I <sub>V</sub> (mcd) (Typ.)	Forward Voltage V <sub>F</sub> (V) (Typ.)	Orderable Part Number
	Red	AllnGaP	20	900	2.0	
IN-P55TATRGB	Green	InGaN	20	1800	3.2	IN-P55TATRGB
	Blue	InGaN	20	600	3.2	

• Bin Range specified on page 3.



#### **Label Specifications**



#### Inolux P/N:

I	Ν	-	Р	5	5	ТА	Т			R	G	В	-	Х	х	х	Х
			Material	Packa	age	Variation	Orientation	Current	Lens	(	Color					mize p-o	
	blux MD		P = PLCC Type	55TA =	5.0 x 5	5.5 x 1.5 mm	T = Top Mount	(Blank) = 20mA per Chip	(Blank) = Clear	G=	632n 520n 470n	m					

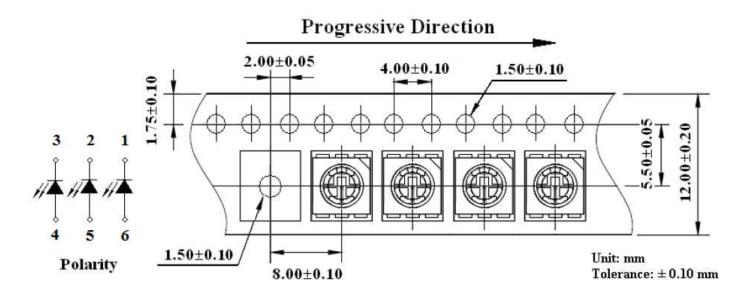
#### Lot No.:

Z	2	0 1		2 0 1		7	01	24	001
Internal Tracker		Year (2017	, 2018,)		Month	Date	Serial		

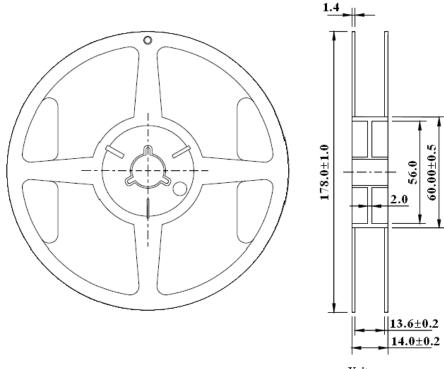


#### Packaging Information: 1000pcs Per Reel

**Tape Dimension** 

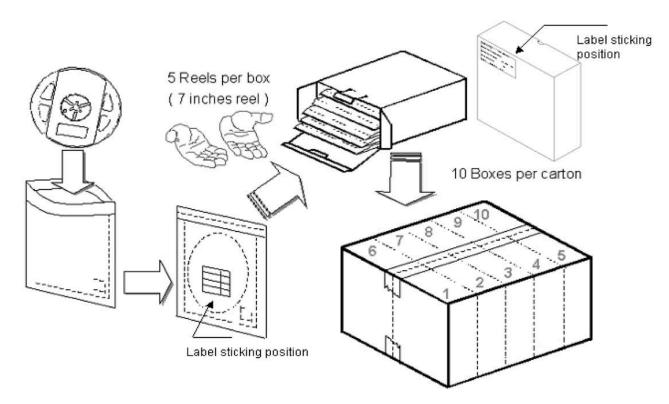


#### **Reel Dimension**





#### Packing Dimension



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	1000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv,  $\lambda_D$  and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

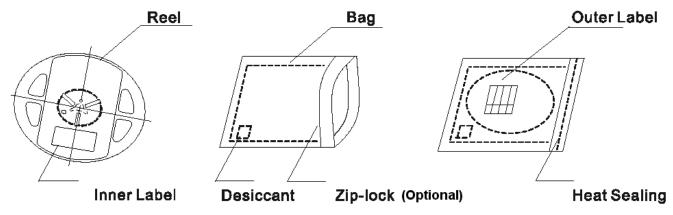


#### **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

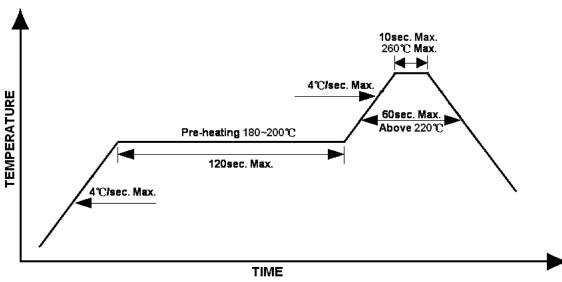
Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



#### **Reflow Soldering**

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



Lead-free Solder Profile



#### Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

#### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

#### Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

#### **Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.



## Reliability

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
	For all reliability	J-STD-020	1.) Baking at 85°C for 24hrs
Precondition	monitoring tests according	0.010.020	2.) Moisture storage at 85°C/ 60% R.H. for
	to JEDEC Level 2		168hrs
	1Q/ 1/ 22/ 0	JESD22-B102-B	Accelerated aging 155°C/ 24hrs
Solderability		And CNS-5068	Tinning speed: 2.5+0.5cm/s
-			Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
		CNS-5067	Dipping soldering terminal only
Resistance to			Soldering bath temperature
soldering heat			A: 260+/-5°C; 10+/-1s
			B: 350+/-10°C; 3+/-0.5s
	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs
Operating life test			85°C/ 60%R.H. for 168hrs
			2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity,	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C
high temperature			Humidity: 85% R.H., IF=5mA
bias			Duration: 1000hrs
High temperature	1Q/ 1/ 20	IN specs.	Tamb: 55°C
bias			IF=20mA
5183			Duration: 1000hrs
	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty
Pulse life test			cycle=0.125 (tp=125 $\mu$ s,T=1sec)
			Duration 500hrs)
	1Q/ 1/ 76/ 0	JESD-A104-A	A cycle: -40 degree C 15min; +85 degree C
Temperature		IEC 68-2-14, Nb	15min
cycle			Thermal steady within 5 min
cycle			300 cycles
			2 chamber/ Air-to-air type
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C
storage test			90+5/-10% R.H. for 500hrs
High temperature	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
storage test			
Low temperature	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs
storage test			



#### **Revision History**

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	04-26-2017

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